1.0 Features

- No-load power consumption < 50mW at 230V<sub>AC</sub> along with fast dynamic load response and short turn-on delay in typical 20W and above adapter applications
- Primary-side feedback eliminates opto-isolators and simplifies design
- Adaptively controlled soft-start enables fast and smooth start-up for a wide range of capacitive loads (from 330μF to 6,000μF) with output voltage up to 12V
- Tight constant-voltage regulation across line and load range
- Proprietary optimized 79kHz maximum PWM switching frequency with quasi-resonant operation achieves best size, efficiency and common mode noise
- User-configurable 5-level cable drop compensation provides design flexibility
- EZ-EMI® design enhances manufacturability
- Adaptive multi-mode PWM/PFM control improves efficiency
- No external loop compensation components required
- Built-in single-point fault protections against output short-circuit, output over-voltage, output over-current, and current-sense-resistor-short fault
- Dedicated pins for external over-temperature protection and over-voltage protection, with latch function available
- Tight constant current control enables output current limit and over-load protection
- No audible noise over entire operating range

2.0 Description

The iW1760 is a high performance AC/DC power supply controller which uses digital control technology to build peak current mode PWM flyback power supplies. The device operates in quasi-resonant mode to provide high efficiency along with a number of key built-in protection features while minimizing the external component count, simplifying EMI design and lowering the total bill of material cost. The iW1760 removes the need for secondary feedback circuit while achieving excellent line and load regulation. It also eliminates the need for loop compensation components while maintaining stability over all operating conditions. Pulse-by-pulse waveform analysis allows for a loop response that is much faster than traditional solutions, resulting in improved dynamic load response. The built-in power limit function enables optimized transformer design in universal off-line applications and allows for a wide input voltage range.

Dialog's innovative proprietary technology ensures that power supplies built with the iW1760 can achieve both highest average active efficiency and less than 50mW no-load power consumption in 20W output power range, and have fast yet smooth start-up with a wide range of capacitive loads with output voltage up to 12V, and are ideal for network and monitor adapter applications.

3.0 Applications

- Power adapters for network devices and monitors
- AC/DC power supplies in home appliances
- Universal input AC/DC adapters (15W - 40W)

Figure 3.1: iW1760 Typical Application Circuit (Using Depletion Mode N-FET as Active Start-up Device)

(Achieving < 50mW No-load Power Consumption in 20W Adapter Designs)
4.0 Pinout Description

<table>
<thead>
<tr>
<th>Pin #</th>
<th>Name</th>
<th>Type</th>
<th>Pin Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>VSENSE</td>
<td>Analog Input</td>
<td>Auxiliary voltage sense (used for primary regulation).</td>
</tr>
<tr>
<td>2</td>
<td>SD</td>
<td>Analog Input</td>
<td>External shutdown control. Used for external over-temperature protection (OTP) by connecting an NTC resistor from this pin to Ground.</td>
</tr>
<tr>
<td>3</td>
<td>CFG</td>
<td>Analog Input</td>
<td>Used for external cable drop compensation (CDC) configuration and supplemental over-voltage protection (OVP).</td>
</tr>
<tr>
<td>4</td>
<td>ASU</td>
<td>Output</td>
<td>Control signal for active start-up device (BJT or depletion mode N-FET).</td>
</tr>
<tr>
<td>5</td>
<td>ISENSE</td>
<td>Analog Input</td>
<td>Primary current sense. Used for cycle-by-cycle peak current control and limit.</td>
</tr>
<tr>
<td>6</td>
<td>OUTPUT</td>
<td>Output</td>
<td>Gate drive for external MOSFET switch.</td>
</tr>
<tr>
<td>7</td>
<td>GND</td>
<td>Ground</td>
<td>Ground.</td>
</tr>
<tr>
<td>8</td>
<td>VCC</td>
<td>Power Input</td>
<td>Power supply for control logic.</td>
</tr>
</tbody>
</table>
## 5.0 Absolute Maximum Ratings

Absolute maximum ratings are the parameter values or ranges which can cause permanent damage if exceeded.

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Value</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>DC supply voltage range (pin 8, $I_{CC} = 20mA$ max)</td>
<td>$V_{CC}$</td>
<td>-0.3 to 18.0</td>
<td>V</td>
</tr>
<tr>
<td>Continuous DC supply current at $V_{CC}$ pin ($V_{CC} = 15V$)</td>
<td>$I_{CC}$</td>
<td>20</td>
<td>mA</td>
</tr>
<tr>
<td>ASU output (pin 4)</td>
<td></td>
<td>-0.3 to 18.0</td>
<td>V</td>
</tr>
<tr>
<td>OUTPUT (pin 6)</td>
<td></td>
<td>-0.3 to 18.0</td>
<td>V</td>
</tr>
<tr>
<td>$V_{SENSE}$ input (pin 1, $I_{Vsense} \leq 10mA$)</td>
<td></td>
<td>-0.7 to 4.0</td>
<td>V</td>
</tr>
<tr>
<td>$I_{SENSE}$ input (pin 5)</td>
<td></td>
<td>-0.3 to 4.0</td>
<td>V</td>
</tr>
<tr>
<td>SD (pin 2)</td>
<td></td>
<td>-0.3 to 4.0</td>
<td>V</td>
</tr>
<tr>
<td>CFG (pin 3, $I_{CFG} \leq 20mA$)</td>
<td></td>
<td>-0.8 to 4.0</td>
<td>V</td>
</tr>
<tr>
<td>Maximum junction temperature</td>
<td>$T_{JMAX}$</td>
<td>150</td>
<td>°C</td>
</tr>
<tr>
<td>Operating junction temperature</td>
<td>$T_{JOPT}$</td>
<td>-40 to 150</td>
<td>°C</td>
</tr>
<tr>
<td>Storage temperature</td>
<td>$T_{STG}$</td>
<td>-65 to 150</td>
<td>°C</td>
</tr>
<tr>
<td>Thermal resistance junction-to-ambient</td>
<td>$\theta_{JA}$</td>
<td>160</td>
<td>°C/W</td>
</tr>
<tr>
<td>ESD rating per JEDEC JESD22-A114</td>
<td></td>
<td>2,000</td>
<td>V</td>
</tr>
<tr>
<td>Latch-up test per JEDEC 78</td>
<td></td>
<td>±100</td>
<td>mA</td>
</tr>
</tbody>
</table>
6.0 Physical Dimensions

8-Lead Small Outline (SOIC) Package

Compliant to JEDEC Standard MS12F

Controlling dimensions are in inches; millimeter dimensions are for reference only.

This product is RoHS compliant and Halide free.

Soldering Temperature Resistance:

[a] Package is IPC/JEDEC Std 020D moisture sensitivity level 1
[b] Package exceeds JEDEC Std No. 22-A111 for solder immersion resistance; package can withstand 10 s immersion < 260˚C

Dimension D does not include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs shall not exceed 0.15 mm per end. Dimension E1 does not include interlead flash or protrusion. Interlead flash or protrusion shall not exceed 0.25 mm per side.

The package top may be smaller than the package bottom. Dimensions D and E1 are determined at the outermost extremes of the plastic body exclusive of mold flash, tie bar burrs, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body.

7.0 Ordering Information

<table>
<thead>
<tr>
<th>Part Number</th>
<th>Options</th>
<th>Package</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>iW1760-00</td>
<td>No OVP/OTP latch</td>
<td>SOIC-8</td>
<td>Tape &amp; Reel\textsuperscript{\textdagger}</td>
</tr>
<tr>
<td>iW1760-01</td>
<td>OVP/OTP latch</td>
<td>SOIC-8</td>
<td>Tape &amp; Reel\textsuperscript{\textdagger}</td>
</tr>
</tbody>
</table>

Note 1: Tape & Reel packing quantity is 2,500 per reel. Minimum ordering quantity is 2,500.
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